

CEM8435A

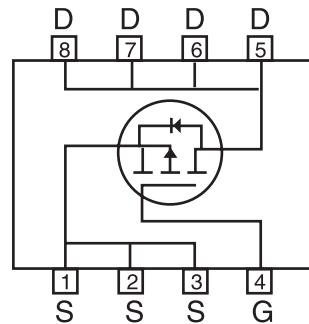
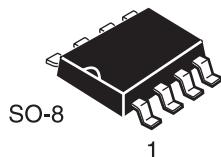
March 1998

P-Channel Enhancement Mode Field Effect Transistor

FEATURES

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- -30V , -7.9A , $R_{DS(ON)}=24m\Omega$ @ $V_{GS}=-10V$.
 $R_{DS(ON)}=40m\Omega$ @ $V_{GS}=-4.5V$.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handing capability.
- Surface Mount Package.



ABSOLUTE MAXIMUM RATINGS (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	-30	V
Gate-Source Voltage	VGS	± 20	V
Drain Current-Continuous ^a @ $T_J=125^\circ C$ -Pulsed ^b	ID	± 7.9	A
	IDM	± 25	A
Drain-Source Diode Forward Current ^a	IS	-2.1	A
Maximum Power Dissipation ^a	PD	2.5	W
Operating Junction and Storage Temperature Range	TJ, TSTG	-55 to 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient ^a	$R_{\theta JA}$	50	°C/W
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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-24V, V_{GS}=0V$			-1	μA
Gate-Body Leakage	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
ON CHARACTERISTICS^b						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1		-3	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-7.0A$			24	$m\Omega$
		$V_{GS}=-4.5V, I_D=-5.8A$			40	$m\Omega$
On-State Drain Current	$I_{D(ON)}$	$V_{DS}=-5V, V_{GS}=-10V$	-25			A
Forward Transconductance	g_{FS}	$V_{DS}=-10V, I_D=-7.0A$		10		S
DYNAMIC CHARACTERISTICS^c						
Input Capacitance	C_{iss}	$V_{DS}=-15V, V_{GS}=0V$ $f=1.0MHz$		2152	2800	pF
Output Capacitance	C_{oss}			1029	1400	pF
Reverse Transfer Capacitance	C_{rss}			270	350	pF
SWITCHING CHARACTERISTICS^c						
Turn-On Delay Time	$t_{D(ON)}$	$V_D=-10V,$ $I_D=-1A,$ $V_{GS}=-10V,$ $R_{GEN}=6\Omega$		15	30	ns
Rise Time	t_r			12	30	ns
Turn-Off Delay Time	$t_{D(OFF)}$			65	120	ns
Fall Time	t_f			50	80	ns
Total Gate Charge	Q_g	$V_{DS}=-15V, I_D=-7.0A,$ $V_{GS}=-10V$		47	60	nC
Gate-Source Charge	Q_{gs}			6		nC
Gate-Drain Charge	Q_{gd}			14		nC

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ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ ^c	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS^b						
Diode Forward Voltage	V_{SD}	$V_{GS} = 0\text{V}$, $I_S = -2.1\text{A}$		-0.75	-1.2	V

Notes

- a. Surface Mounted on FR4 Board, $t \leq 10\text{sec}$.
- b. Pulse Test: Pulse Width $\leq 300\ \mu\text{s}$, Duty Cycle $\leq 2\%$.
- c. Guaranteed by design, not subject to production testing.

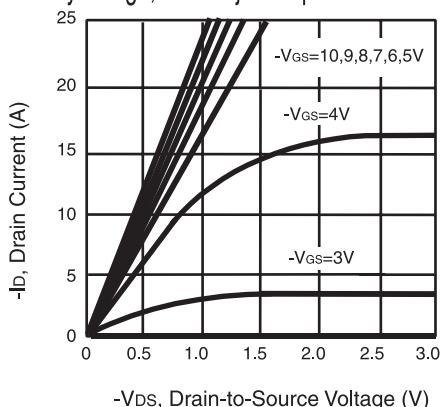


Figure 1. Output Characteristics

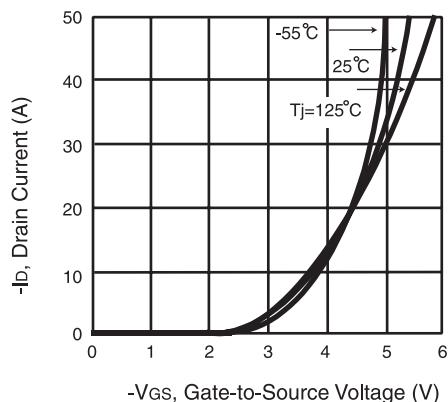


Figure 2. Transfer Characteristics

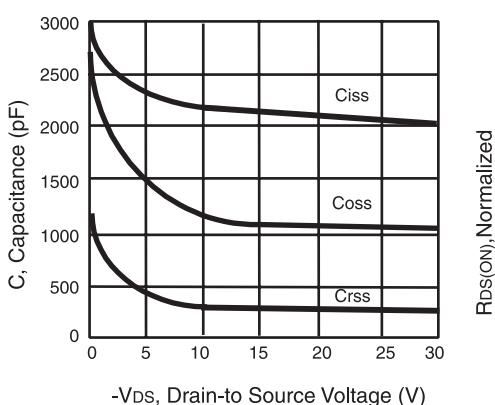


Figure 3. Capacitance

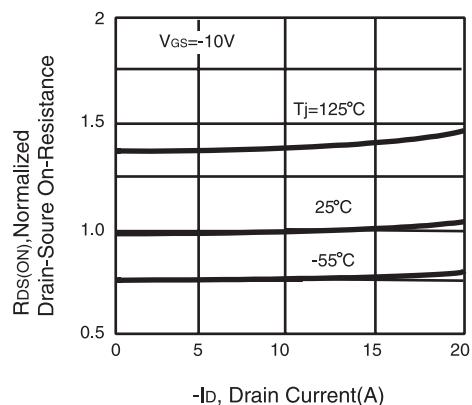


Figure 4. On-Resistance Variation with Drain Current and Temperature

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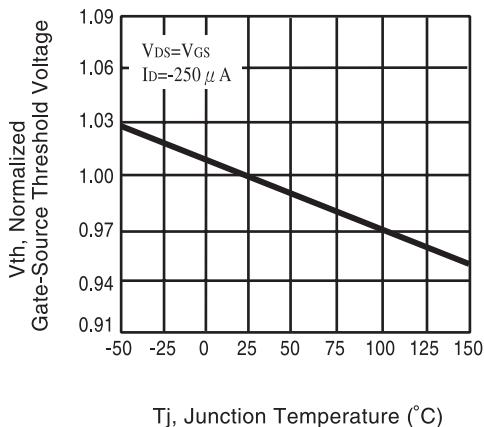


Figure 5. Gate Threshold Variation with Temperature

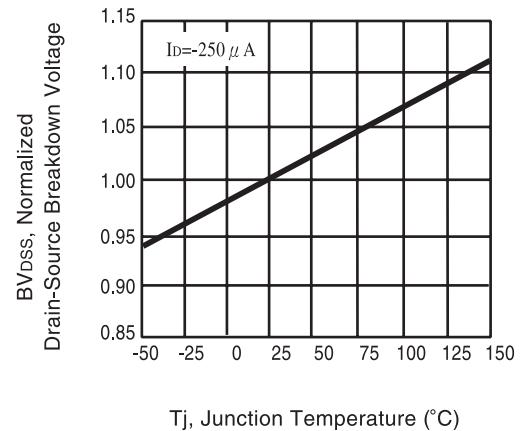


Figure 6. Breakdown Voltage Variation with Temperature

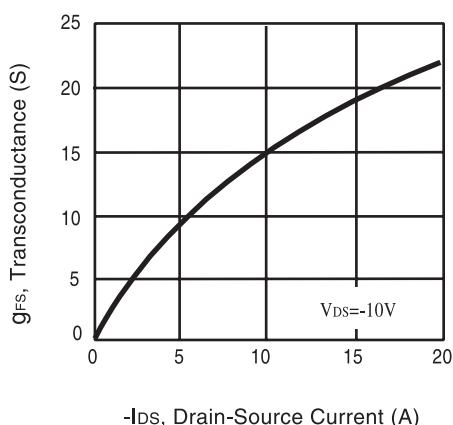


Figure 7. Transconductance Variation with Drain Current

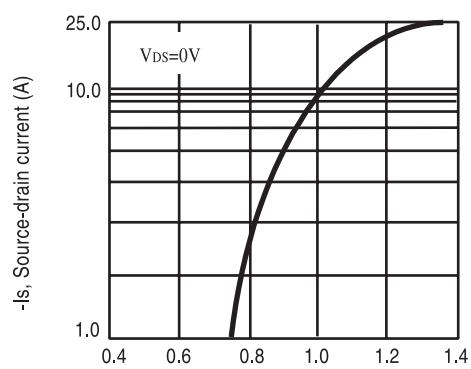


Figure 8. Body Diode Forward Voltage Variation with Source Current

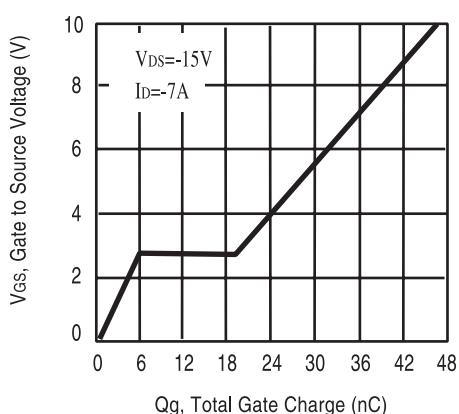


Figure 9. Gate Charge

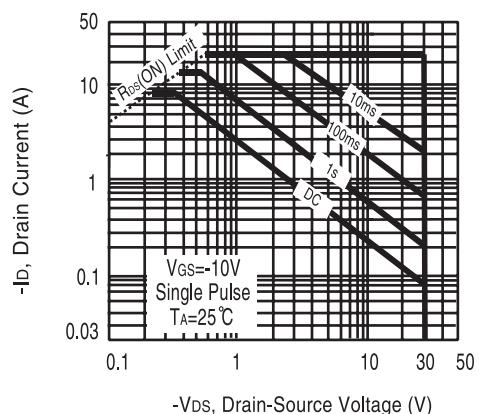


Figure 10. Maximum Safe Operating Area

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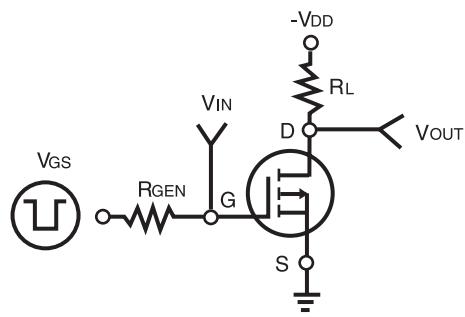
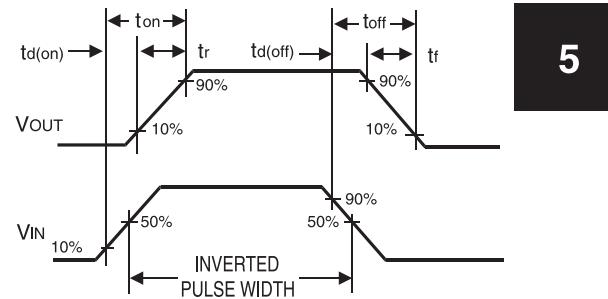


Figure 11. Switching Test Circuit



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Figure 12. Switching Waveforms

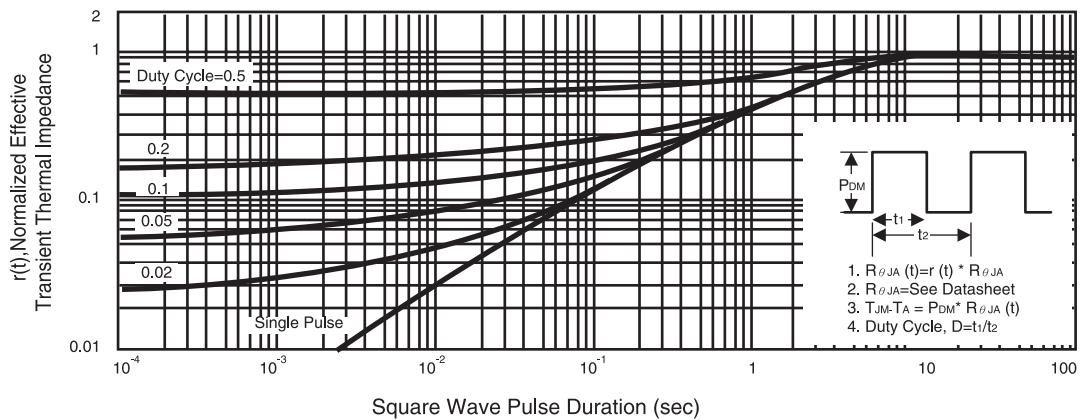


Figure 13. Normalized Thermal Transient Impedance Curve